

Technical Data Sheet

Electronic Coating Materials

Epoxylite[®] E 5403 DP Hi Temp

Two-Component Epoxy Adhesive and Sealant

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EpoxyLite® E 5403 DP Hi Temp Epoxy

Product Description

EpoxyLite® E 5403 DP Hi Temp Epoxy is a heat-cured, two-component system consisting of a viscous liquid resin and a finely divided powder hardener. It is provided in pre-measured kits.

Areas of Application

Bonding and sealing of electrical and electronic components requiring resistance to high temperatures

Features and Benefits

- Maintains excellent electrical and physical properties to at least 260°C / 500°F
- Withstands temperatures in excess of 316°C / 600°F for short periods
- Excellent adhesion to metals, ceramics and most plastics
- Resistant to acids, alkalis and solvents.

Application Methods

- Brush or spatula
- Syringe

Transportation / Storage

Store below 25°C / 77°F in a dry controlled environment out of direct sunlight. This material should be suitable for use stored under these conditions in the original sealed containers for six (6) months from the date of shipment.

Failure to store the product as recommended above may lead to deterioration in product performance.

This product is sensitive to moisture and atmospheric humidity. Containers, once opened, should be used immediately or blanketed with dry nitrogen before resealing.

Mix individual components thoroughly before use.

Health / Safety

Refer to the Safety Data Sheet.

See ELANTAS PDG Technical Bulletin *TI-100 - Handling Precautions for Epoxy Resins* for additional information.

Typical Properties of Material as Supplied

Property	Conditions	Value		Units
		EpoxyLite® E 5403 DP Hi Temp Resin	EpoxyLite® C 5403 DP Hi Temp Hardener	
Form	25°C / 77°F	paste	powder	
Weight per Gallon	25°C / 77°F	13.3 - 13.7	14.7 - 15.1	
Flash Point	ASTM D93	> 94 > 201	> 94 > 201	°C °F
Mix Ratio	Parts by weight	100	28	

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Regulatory Information

Property	Test Method	Value	Units
Volatile Organic Content	ASTM D6053	0.2 ^[1]	pounds / gallon

^[1] VOC test methods and limits vary widely by regulatory jurisdiction and product application. The value above was obtained by curing a thin film under specific laboratory conditions.

Mixing / Application

Best results will be obtained by warming the Resin to 65 – 85°C / 150 – 185°F before addition of the Hardener. This will lower the viscosity and facilitate release of bubbles.

Do not use less than the pre-packaged amounts as the powdered Hardener may vary in composition within the container.

Mix the Hardener into the warm Resin with mechanical agitation until homogeneous (3 - 6 minutes). Pot life of the mixture is 8 - 12 hours at room temperature, less at elevated temperature.

Mixed material that is not used immediately must be stored in a container free of air or blanketed with nitrogen. Pot life can be extended with refrigeration (5°C / 41°F) to several days, or with freezing (-40°C / -40°F) to several months.

Refrigerated or frozen containers should be thawed to 16°C / 60°F or higher before opening to avoid moisture condensation.

NOTE: Proper surface preparation is critical to obtaining optimum product performance. See ELANTAS PDG Technical Bulletin TI-3000 *Surface Preparation Recommendations*.

Epoxylite® E 5403 DP Hi Temp Epoxy is highly adhesive. Surfaces that may come into accidental contact with it during processing should be pretreated with a suitable release agent.

Curing Schedule

Cure as follows:

16 hours at 93°C / 200°F – **OR** – 4 hours at 121°C / 250°F – **OR** –
1 hour at 177°C / 350°F – **OR** – 30 minutes at 204°C / 400°F

Higher temperatures cures will exhibit higher shrinkage and should be avoided if this is a critical concern.

A post-cure of one hour at 204°C / 400°F should be used when the highest possible heat resistance is required.

The cure schedules above are based on time after the unit reaches the specified temperature and are recommendations only. The user is responsible for determining the optimum cure conditions for their application.

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Typical Mechanical Properties

Property	Method	Conditions	Value	Units
Shore Hardness	ASTM D2240	25°C / 77°F	D 90	
Glass Transition Temp. (T _g)	ASTM E831	TMA	220	°C
Coefficient of Thermal Expansion	ASTM E831	Below T _g	45	ppm / °C
Linear Shrinkage	ASTM D2566	100°C cure	< 1	%
Weight Loss	ASTM D3377	168 h at 180°C / 356°F	< 1	%
Lap Shear Strength Aluminum to aluminum	ASTM D1002	25°C / 77°F 260°C / 500°F	1800 400	psi psi
Elongation	ASTM D638	25°C / 77°F	< 1	%
Flexural Strength	ASTM D790	25°C / 77°F	10,000	psi
Compressive Strength	ASTM D695	25°C / 77°F	40,000	psi

Typical Electrical Properties

Property	Method	Conditions	Value	Units
Dielectric Strength	ASTM D149	25°C / 77°F – 125 mils	560	volts/mil
Dissipation Factor	ASTM D150	60 Hz - 25°C / 77°F	0.03	
Volume Resistivity	ASTM D257	25°C / 77°F	1 X 10 ¹⁶	ohm-cm

The above properties are typical values and are not intended for specification use.

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